

NCE N-Channel Super Trench II Power MOSFET

Description

The NCEP045N10G uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

General Features

- V_{DS} =100V, I_D =125A $R_{DS(ON)}$ =3.8m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

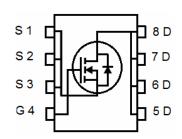
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|-------------|----------------|-----------|------------|----------|
| P045N10G | NCEP045N10G | DFN5X6-8L | - | - | - |

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|-----------------------|------------|--------------|
| Drain-Source Voltage | VDS | 100 | V |
| Gate-Source Voltage | V _G s | ±20 | V |
| Drain Current-Continuous | I _D | 125 | А |
| Drain Current-Continuous(T _C =100 °C) | I _D (100℃) | 90 | Α |
| Pulsed Drain Current | I _{DM} | 500 | Α |
| Maximum Power Dissipation | P _D | 150 | W |
| Derating factor | | 1.2 | W/℃ |
| Single pulse avalanche energy (Note 5) | E _{AS} | 720 | mJ |
| Operating Junction and Storage Temperature Range | T_{J}, T_{STG} | -55 To 150 | $^{\circ}$ C |

Thermal Characteristic

| Thermal Resistance, Junction-to-Case ^(Note 2) | $R_{	hetaJC}$ | 0.83 | °C/W |
|--|---------------|------|------|



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Electrical Characteristics (T_C=25°C unless otherwise noted)

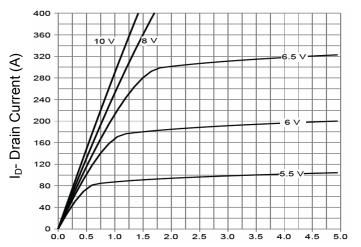
| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|---|-----|------|----------|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250µA | 100 | | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =100V,V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V_{GS} =±20 V , V_{DS} =0 V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | • | • | | • |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}$, $I_{D}=250\mu A$ | 2 | 3 | 4 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =65A | - | 3.8 | 4.5 | mΩ |
| Forward Transconductance | g FS | V _{DS} =5V,I _D =65A | | 120 | - | S |
| Dynamic Characteristics (Note4) | | | | · | | |
| Input Capacitance | C _{lss} | | - | 5500 | - | PF |
| Output Capacitance | C _{oss} | V_{DS} =50V, V_{GS} =0V, | - | 600 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.0MHz | - | 21 | - | PF |
| Switching Characteristics (Note 4) | | | | · | | |
| Turn-on Delay Time | t _{d(on)} | | - | 21 | - | nS |
| Turn-on Rise Time | t _r | V_{DD} =50 V , I_{D} =65 A , | - | 13 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =10 V , R_{G} =3 Ω | - | 40 | - | nS |
| Turn-Off Fall Time | t _f | | - | 12 | - | nS |
| Total Gate Charge | Qg |)/ F0)/ OFA | - | 93 | - | nC |
| Gate-Source Charge | Q _{gs} | $V_{DS}=50V, I_{D}=65A,$ | - | 21 | | nC |
| Gate-Drain Charge | Q _{gd} | V _{GS} =10V | - | 27 | | nC |
| Drain-Source Diode Characteristics | | | • | l | <u> </u> | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =65A | - | | 1.2 | V |
| Diode Forward Current (Note 2) | Is | | - | - | 125 | Α |
| Reverse Recovery Time | t _{rr} | $T_J = 25^{\circ}C, I_F = 65A$ | - | 68 | - | nS |
| Reverse Recovery Charge | Qrr | $di/dt = 100A/\mu s^{(Note3)}$ | - | 115 | - | nC |

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\!\!\mathrm{C}$,V $_{DD}$ =50 V ,V $_{G}$ =10 V ,L=0.5 mH ,Rg=25 Ω

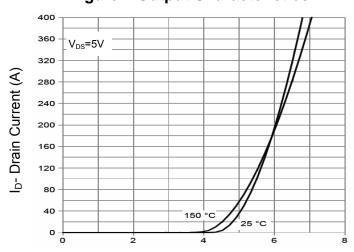


Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

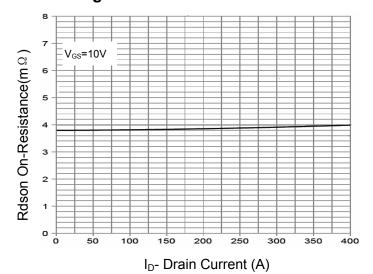


Figure 3 Rdson- Drain Current

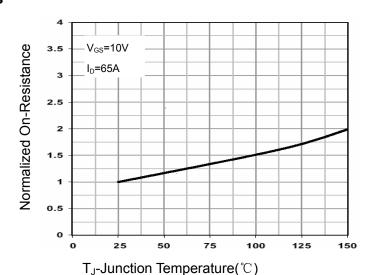
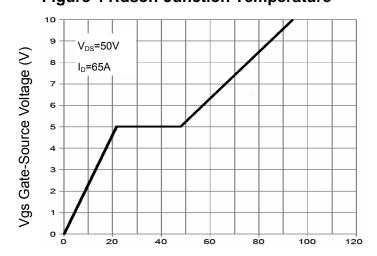
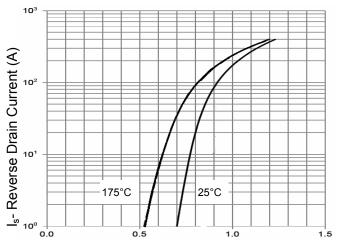


Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge



Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



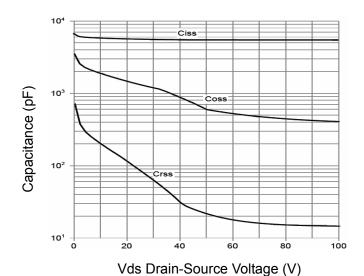
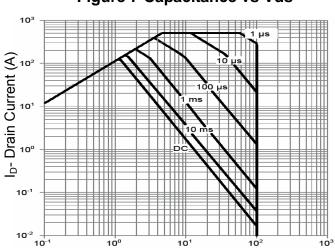
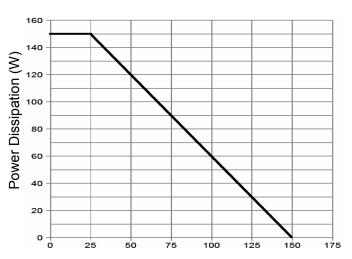


Figure 7 Capacitance vs Vds



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area



T_J-Junction Temperature(°C)

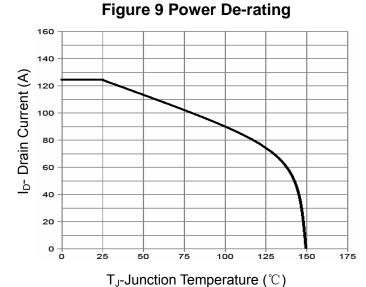


Figure 10 Current De-rating



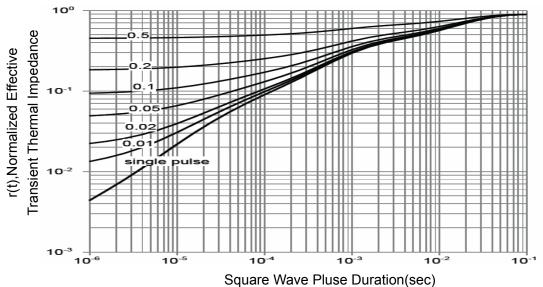
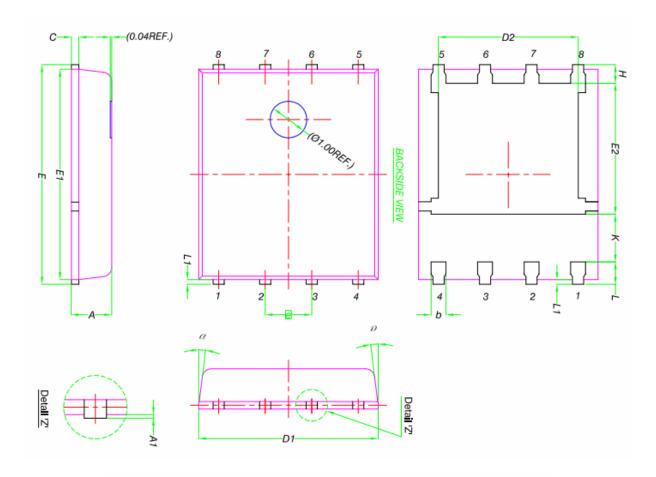


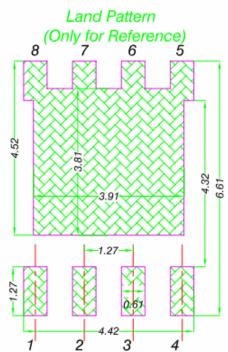
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



| 5.44 | MILLIMETERS | | | | |
|------|-----------------------------|------|-------------------|--|--|
| DIM. | MIN. | NOM. | MAX. | | |
| Α | 0.90 | 1.00 | 1.10 | | |
| A1 | 0 | - | 0.05 | | |
| b | 0.33 | 0.41 | 0.51 | | |
| С | 0.20 | 0.25 | 0.30 | | |
| D1 | 4.80 | 4.90 | 5.00 | | |
| D2 | 3.61 | 3.81 | 3.96 | | |
| Ε | 5.90 | 6.00 | 6.10 | | |
| E1 | 5.70 | 5.75 | 5.80 | | |
| E2 | 3.38 | 3.58 | 3.78 | | |
| е | | | | | |
| Н | 0.41 | 0.51 | 0.61 | | |
| К | K 1.10 L 0.51 L1 0.06 | | - 0.71 0.20 | | |
| L | | | | | |
| L1 | | | | | |
| α | <i>0</i> ° | - | 12° | | |



NCEP045N10G

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